



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Paul A. Farrar
 Title: PACKAGING OF ELECTRONIC CHIPS WITH AIR-BRIDGE STRUCTURES
 Docket No.: 303.603US1
 Filed: August 25, 1999
 Examiner: David E. Graybill

Serial No.: 09/382,929
 Due Date: September 14, 2002
 Group Art Unit: 2827

Commissioner for Patents
 Washington, D.C. 20231

We are transmitting herewith the following attached items (as indicated with an "X"):

- ☒ A return postcard.
- ☒ An Amendment and Response (6 Pages).
- ☒ A Clean Version of Pending Claims (5 pgs.).
- ☒ A Supplemental Information Disclosure Statement (1 pg.), Form 1449 (1 pg.), and copies of 4 cited references.

Please consider this a **PETITION FOR EXTENSION OF TIME** for sufficient number of months to enter these papers and please charge any additional required fees or credit overpayment to Deposit Account No. 19-0743.

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CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: Commissioner for Patents, Washington, D.C. 20231, on this 16 day of September, 2002.

Tina Khorst
 Name

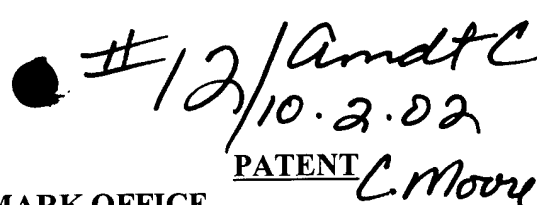
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IN THE CLAIMS

Please cancel claim 13 without prejudice or disclaimer.

22. (Amended) The integrated circuit assembly of claim 18, wherein the material is carbon [dioxide].
32. (Amended) The integrated circuit assembly of claim 31, wherein the post structure is fabricated from carbon [the same material as the air-bridge structure].
35. (Amended) The integrated circuit assembly of claim 34 [31], wherein the insulator is silicon dioxide.

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